# **Tyrone Camarero Specifications**

# ivrone

# Camarero- SDI100A2TF-46

## **Kev Feature**

- Hyperscale / Hyperconverged, HPC and Big Data, Data Center Enterprise Applications, Scale-Out Storage, Virtualization Server, Telco Data Center
- Eight hot-pluggable systems (nodes) in a 4U form factor. Each node supports the following:
- Socket P+(LGA 4189) Supports 3rd Generation Intel® Scalable Processors (Dual Socket)
- 16 DIMMs Supports up to 4TB Intel® Optane Persistent Memory 200 Series; up to 2TB DDR 4-3200, Two M.2 Internal Drives
- Network Connectivity Via AIOM (OCP 3.0 Compliant), NVMe/SATA/SAS options
- AIOM and M.2 support; 1 AIOM card support (PCle 4.0)
- Front access node for better serviceability; 6x 2.5" hot-swap HDDs per node, Up to 6x SAS/-SATA/NVMe Hot Swap 2.5" Drives
- Fans: 3x 4cm Fan(s)
- 8800W Redundant Titanium Level power supplies





#### Processor/Cache

Dual Socket P+ (LGA-4189), 3rd Gen Intel® Xeon® Processor

Scalable processors, Up to 36C/72T; Up to 54MB

Cache per CPU

#### System Memory

Memory Capacity 16 DIMMs Supports up to 4TB Intel® Optane Persistent Memory 200 Series; up to 2TB DDR 4-3200, Two M.2 Internal

Drives

#### Chipset

Chipset Intel® C621A Chipset

#### **Expansion Slot**

Expansion

1 PCle 4.0 x8 LP slot(s)

#### Integrated Onboard:

SATA 14 SATA (6Gbps) port(s)

**NVME** 6 NVMe U.2 options

1 RJ45 Dedicated IPMI LAN port LAN

### Add-on Options

Raid Card None

Optical Drive None Front Panel

HDD activity LEDNetwork activity **LED** 

LEDs, Power status LED, Universal

Information (UID) LED

**Buttons** Power On/Off button, UID button

Drive bays

6x 2.5" hot-swap NVMe/SATA/SAS **HDD Bays** 

drive bays (6x 2.5" NVMe hybrid), 6x

2.5" 7mm drive bays

**Power Supply** 

8800W Redundant Titanium Level **Power Supply** 

power supplies

Cooling System

3x 4cm Fan(s) Fans

Form Factor

Form Factor 4U Rackmount

**Dimensions** 

Height - 6.96" (177mm), Width - 17.63" **Dimensions** 

(448mm), Depth -29" (737mm)

Email: Info@tyronesystems.com For more/current product information, Visit www.tyronesystems.com

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